# $\mu \textbf{RWELL Detector R\&D for EIC} \\ \textbf{and Others} \\$

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KU SNU Mini-workshop @ Kyushu University



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- Introduction to  $\mu RWELL$
- Working principle
- Low and high rate  $\mu RWELL$
- Production process
- The ePIC experiment
- Physics goal
- Contribution plan toward GEM +  $\mu$ RWELL ECT
- DAMSA, LHCb?, Future collider?
- Current R&D status

- Micro Resistive WELL, a resistive variant of GEM
- Resistive layer, DLC, prevents streamer from evolving discharge
- No spatial separation between the avalanche and induction region is required
- $\rightarrow$  Self-rigidity  $\Rightarrow$  Simpler detector structure  $\Rightarrow$  Cost effective



- Position resolution ~ 70μm Time resolution ~ 5-7 ns



- High rate  $\mu$ RWELL
- Rate capability of  $\mu$ RWELL is limited due to voltage drop occurring charge drain



- The rate capability can be restored through additional grounds
- ePIC, DAMSA  $\rightarrow$  Low rate  $\mu$ RWELL LHCb, CLAS12  $\rightarrow$  High rate  $\mu$ RWELL



#### • GEM and $\mu$ RWELL share production process



- Gluing
- Cu etching
- PI etching
- Cleaning to give HV stability
- DLC-FCCL
- Sputtering
- Will be done in CERN MPT
- Looking for domestic companies as well



# 2. ePIC Experiment

• BNL is building a new polarized electron ring around RHIC



- To understand how spin and mass of proton emerge from its constituents
- To understand proton structure in higher dimension i.e. TMD and GPD
- To understand pion and kaon(?) structure
- Gluon saturation exists or not

# 2. ePIC Experiment – Spin



- EMC experiment (Nuclear Physics B 328, 1 (1989)) revealed spin carried by quarks ( $\Delta\Sigma$ ) was surprisingly small < 0.12
- Series of polarized DIS and SIDIS
- → Proton Spin Crisis!

puzzling result was termed the "proton spin crisis".<sup>[4]</sup> The problem is considered one of the important unsolved problems in physics.<sup>[5]</sup>

- Jaffe-Monohar sum rule
- $-S^p = \frac{1}{2} = \frac{1}{2}\Delta\Sigma + L_z^q + \Delta G + L_z^g$

 $\rightarrow$  We should not ignore gluon and angular momentum contribution!

#### 2. ePIC Experiment – Spin

• Inclusive 
$$A_{LL}$$
  
$$\frac{1}{2} \left[ \frac{d^2 \sigma^{\Leftarrow}}{dx dQ^2} - \frac{d^2 \sigma^{\Rightarrow}}{dx dQ^2} \right] \cong \frac{4\pi \alpha^2}{Q^4} y(2-y) g_1(x,Q^2)$$

, where  $g_1(x, Q^2) = \frac{1}{2} \sum e_q^2 [\Delta q(x, Q^2) + \Delta \bar{q}(x, Q^2)].$ 

-  $\Delta g$  is encoded in scale violation of  $g_1$ 



# 2. ePIC Experiment – Gluon Saturation

- Will gluon density continue to increase in low enough x region?
  - Probably not



BK evolution

 $-\frac{\partial N(x,r_T)}{\partial \ln(1/x)} = \alpha_S K_{BFKL} \otimes N(x,r_T) - \alpha_S [N(x,r_T)]^2$ 

HERA implied the existence of CGC



 $Y = \ln 1/x$ 

## **2. ePIC Experiment – Gluon Saturation**

- Nuclear "Oomph" factor
  - To access CGC, we need higher beam energy or heavy ion collision
- Gluon fields are overlapped by Lorentz contraction and higher density gluon field can be probed wo/ increasing beam energy





# 2. ePIC Experiment – ECT



# 2. ePIC Experiment – ECT

- "Main risk is related to CERN being the unique producer of  $\mu \text{RWELL}$  detector layer"
- $\rightarrow$  Korea can mitigate this risk
- In-kind contribution of GEM &  $\mu RWELL$  for the ECT project
- 2.2 M USD is very likely
- PI: Prof. Seonho Choi
- Starter of the Korean  $\mu$ RWELL R&D

	DURATION			
START DATE	END DATE	DESCRIPTION	(years)	
3/1/24	12/31/24	Detectors Overall Design	<1	
1/1/25	12/31/26	Pre - Production	2	
1/1/27	31/12/29	Production & QA	3	
1/1/30	6/1/30	Commissioning & Installation	0.5	

# **3. DAMSA Experiment**

• Search for  $a \to \gamma \gamma$  and  $A' \to e^+e^-$  using the beam dump of Fermi Lab. L'ANNA KANA PIP 2

" "

- PRD 107 L031901 2023

-  $\mu$ RWELL tracker with XY 128\*128 capacitive sharing RO

The key of the DAMSA experiment is to place

the detector directly behind the beam dump



## **4. LHCb?**

• LHCb will replace MWPC to (GEM +) high rate  $\mu$ RWELL

- Due to limited rate capability of MWPC

• 574 chambers to cover  $40 m^2$ 

- Producing all necessary µRWELL @ CERN MPT alone may not be possible

- If LHCb chooses GRWELL as it seems to be leaning toward recently, it will be nearly impossible to complete production solely through CERN MPT

Journal of Instrumentation	<u></u>
OPEN ACCESS	
The µ-RWELL layouts for high particle rate	Recent citations
To cite this article: G. Bencivenni et al 2019 JINST 14 P05014	<ul> <li>Development of Micromegas detectad with resistive anode pads</li> <li>M. Chefdeville et al</li> </ul>
View the <u>article online</u> for updates and enhancements.	Position-Sensitive Thermal and Cold Neutron Detectors with SS_(2)*(3)(tent(Hei))SS Gas Converts (Review) A. P. Kashchuk and O. V. Levitskaya
0	The Well (micro-Well) Electron Multip with the DLQanode—a key element robust and fast 2D-position sensitive MPGD A Kashchuk et a/
Farens	$\sim$





## **5. Future Collider?**

• Not sure which collider will be realized. However, it's clear that  $\mu$ RWELL will be crucial in new experiment

- IDEA plan requires so many  $50\times50cm^2~\mu \rm RWELL$  for pre-shower (520) and muon station (1520)



# 6. Current Status

- Procurement for  $\mu$ RWELL production R&D
- DLC-FCCL
  - 1 XY 128\*128 Ch. RO PCB
  - Gas frame, o-ring, ETC were delivered from CERN MPT
- 1 Ch. RO PCBs for test produced in Korea
- DAQ for the R&D and DAMSA experiment
- Purchasing SRS system with VMM3a hybrid card



#### 6. Current Status – Gluing



- Pressing DLC FCCL, pre-preg and RO PCB at high temperature in a vacuum chamber
- Common technique in PCB maker
- Use only 7-10 bar, half of common PCB process, not to damage Cu layer
- At such low pressure, flatness control is crucial Pressure regularization also is crucial
- $\Rightarrow$  Know-how in "stack" construction is important



# 6. Current Status – Gluing

- The first press work attempted, evaluating results
- Not perfect but promising result is obtained
- Flatness seems fine, but pressure regulation was insufficient
   Glass wool pattern from Pre-Preg visible on Cu layer
   Will retry with a different pressure regulation pad
- Cu etching will be attempted soon



Vacuum hot press

#### Summary

- $\mu$ RWELL, resistive variant of GEM, is very promising technology
- Free from discharge & simpler structure

- Using expertise we've accumulated during the CMS GEM project, SNU can produce  $\mu \text{RWELL}$ 

- The ECT of the ePIC experiment is the first contribution site
- Many fundamental nuclear physics goals will be covered by the ePIC
- The budget for the in-kind contribution is secured
- The DAMSA experiment is the second
- Hope to contribute to LHCb and future collider experiments
- Attempted the first  $\mu$ RWELL production step: glue process
- Not perfect but promising result is obtained





• Working principle

Ionization  $\rightarrow$  Drift  $\rightarrow$  Multiplication  $\rightarrow$  Signal induction  $\rightarrow$  Charge drain

Limitation of MWPC

⇒ Mechanical complexity → lack of scalability Limited multi-track resolution  $\sim O(10mm)$ Not enough rate capability Aging



#### Fabio Sauli

# 1. Introduction to $\mu$ RWELL

- Micro Strip Gaseous Counter
- Susceptible to discharges
- Streamer formation
  - Field distortion by space charge and secondary avalanche by UV
  - $\rightarrow P_{discharge} \sim e^{gain}$
  - $\Rightarrow$  Necessity of quenching gas
- For rate capability and multi-track resolution, micro patterning was the right direction to go
- $\Rightarrow$  Preventing discharges became the key of MPGD
- $\rightarrow$  Step by step amplification & separation of induction and amplification region
- $\rightarrow$  Resistive layer







#### 2. Production processes

• The DLC layer is formed by a sputtering process and are procured by ordering it from CERN or other suppliers



- Pressing DLC FCCL, pre-preg and RO PCB at high temperature in a vacuum chamber
- Will be done by PCB maker
- Common PCB pressing process, but requires know-how to construct "stack" to control the flatness issue



# 2. Production processes



• PI layer etching

- KOH, amine Service Area Active Area Service Area



# 2. Production processes



- Soldering connectors and cleaning
- C-cleaning & E-cleaning needs lots of know-how
- We have the know-how through KCMS GEM production



# 7. Introduction to high rate $\mu$ RWELL

• PI etching



• Drilling (CNC)



Plating



- Gas electron multiplier
- Step-by-step amplification & separation of induction and amplification region



- Advantages of GEM
- Good position and multi-track resolution
- Fair time resolution
- Extremely robust to classical aging
- Extremely high rate capability
- $\rightarrow$  Nice detectors for high rate experiments and imaging application

- Micro resistive well, the resistive variant of GEM
- Resistive layer, DLC, prevents streamer from evolving discharge
- No spatial separation between the avalanche and induction regions is required





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- Simpler structure and easier assembly
- Self rigidity due to RO
- One foil is enough
- Simpler HV supply

 $\Rightarrow$  Cheap





# 2. Proton spin structure and PHENIX experiment

#### RHIC spin program

- Polarized p+p collision @  $\sqrt{s}$  = 200 and 510 GeV
- Jet and hadron  $A_{LL}$  to constrain  $\Delta G @$  LO



$$A_{LL}^{h} = \frac{\sigma_{++} - \sigma_{+-}}{\sigma_{++} + \sigma_{+-}}$$

$$= \frac{\sum_{f_{a,b}=q,\bar{q},g} \Delta f_a \otimes \Delta f_b \otimes \Delta \hat{\sigma}_{elastic}^{a+b \to c+X} \otimes D_c^h}{\sum_{f_{a,b}=q,\bar{q},g} f_a \otimes f_b \otimes \hat{\sigma}_{elastic}^{a+b \to c+X} \otimes D_c^h}$$

$$= \frac{\sum_{f_{a,b}=q,\bar{q},g} \Delta f_a \otimes \Delta f_b \otimes \hat{\sigma}_{elastic}^{a+b \to c+X} \times \hat{a}_{LL}^{a+b \to c+X} \otimes D_c^h}{\sum_{f_{a,b}=q,\bar{q},g} f_a \otimes f_b \otimes \hat{\sigma}_{elastic}^{a+b \to c+X} \otimes D_c^h}$$



$$\Delta f = f^{\uparrow} - f^{\downarrow}$$

#### **EIC Scope**



#### Physics programs – spin structure of proton

• OAM

- As  $S_q$  and  $S_g$  are expected to be precise, OAM will be constrained

-  $J^q = \frac{1}{2} - J^g = \frac{1}{2} \int dx x [H^q(x, \xi = 0, t = 0) + E^q(x, \xi = 0, t = 0)]$ , where *H* and *E* are GPD

 $OAM_q = J^q - S_q$  and  $OAM_g = J^g - S_g$ 

- H and E are accessible at EIC and JLab via DVCS and DVMP



#### Physics programs – Multi. D. imaging of proton



# Physics programs – GPDs

- GPDs provide a connection between PDFs and form factors
- The cleanest channels to access GPDs are DVCS and DVMP
- $x + \xi$  and  $x \xi$  are longitudinal parton momentum fractions with respect to the average proton momentum  $\frac{p+p'}{2}$  before and after scattering



#### Physics programs – TMDs

•  $\frac{d\sigma}{dxdyd\phi_Sdzd\phi_hdP_{hT}^z} \propto F_{UU} + |S_{\perp}| \sin(\phi_h - \phi_S) F_{UT}^{\sin(\phi_h - \phi_S)} + \cdots$ , where  $F_{UT}^{\sin(\phi_h - \phi_S)} = \sum_q e_q^2 |C_V(Q)|^2 [R(Q;\mu_0) \otimes f_{1T}^{\perp q}(x;\mu_0) \otimes D_1^q(z;\mu_0)] (P_T)$ , where  $|C_V(Q)|^2$  perturbative coefficient,  $R(Q;\mu_0)$  evolution factor,  $f_{1T}^{\perp q}(x;\mu_0)$ 

Sivers TDM, and  $D_1^q$  (z;  $\mu_0$ ) unpolarized TMD FF



# Physics programs – Gluon saturation

- Will gluon density continue to increase in low enough x region?
  - Probably not



- BFKL evolution
- The evolution eq. that allows one to construct the PDF at low-x -  $\frac{\partial N(x,r_T)}{\partial \ln(1/x)} = \alpha_s K_{BFKL} \otimes N(x,r_T)$ , where  $r_T \sim 1/Q$  (transverse distance) and Fourier Tr. of  $N(x,r_T)$  is related to gluon TMD
- BK evolution

$$\frac{\partial N(x,r_T)}{\partial \ln(1/x)} = \alpha_S K_{BFKL} \otimes N(x,r_T) - \alpha_S [N(x,r_T)]^2$$

• HERA implied the existence of CGC



# Physics programs – Gluon saturation

Nuclear "Oomph" factor

- To access CGC, we need higher beam energy or heavy ion collision

- Gluon fields are overlapped by Lorentz contraction and higher density gluon field can be probed wo/ increasing beam energy

- 
$$Q_s^2(x) \sim A^{1/3}(\frac{1}{x})^{\lambda}$$
 where  $\lambda = 0.2 - 0.3$ 

- Observables
- Nuclear structure function
- Di-hadron correlations
- Diffractive events





# 4. High rate $\mu$ RWELL application – LHCb

- Replacement of MWPC to high rate  $\mu$ RWELL
- Due to limited rate capability of MWPC
- 574 chambers to cover 40  $m^2$
- Production will start ~2027
- Recently, the leader of the LHCb upgrade suggested collaboration
- PCB production @ Eltos, Italy
- μRWELL @ KCMS

 CERN has transferred technologies of μRWELL production to Eltos for FCC-ee
 However, Eltos failed in PI etching and is focusing on PCB production

 Need intensive technology R&D and mass production



Rates (kHz/cm <sup>2</sup> )	M2	M3	M4	M5
R1	749	431	158	134
R2	74	54	23	15
R3	10	6	4	3
R4	8	2	2	2

